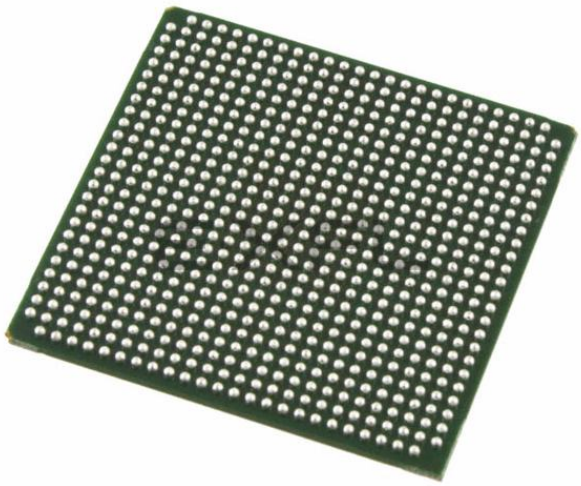
Lattice Semiconductor Corporation - LFE2-70E-5FN672C Datasheet



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Details	
Product Status	Active
Number of LABs/CLBs	8500
Number of Logic Elements/Cells	68000
Total RAM Bits	1056768
Number of I/O	500
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2-70e-5fn672c

SERDES Power Supply Requirements (LatticeECP2M Family Only)[1]

Over Recommended Operating Conditions

Symbol	Description	Typ.[2]	Units
Standby (Power Down)			
$I_{CCTX-SB}$	V_{CCTX} current (per channel)	10	µA
$I_{CCRX-SB}$	V_{CCRX} current (per channel)	75	µA
$I_{CCIB-SB}$	Input buffer current (per channel)	0	µA
$I_{CCOB-SB}$	Output buffer current (per channel)	0	µA
I_{CCP-SB}	SERDES PLL current (per quad)	30	µA
$I_{CCAX33-SB}$	SERDES termination current (per quad)	10	µA
Operating (Data Rate = 3.125 Gbps)			
$I_{CCTX-OP}$	V_{CCTX} current (per channel)	19	mA
$I_{CCRX-OP}$	V_{CCRX} current (per channel)	34	mA
$I_{CCIB-OP}$	Input buffer current (per channel)	4	mA
$I_{CCOB-OP}$	Output buffer current (per channel)	13	mA
I_{CCP-OP}	SERDES PLL current (per quad)	26	mA
$I_{CCAX33-OP}$	SERDES termination current (per quad)	0.01	mA

1. Equalization enabled, pre-emphasis disabled.
2. T_J = 25°C, power supplies at nominal voltage.

SERDES Power (LatticeECP2M Family Only)

Table 3-1 presents the SERDES power for one channel.

Table 3-1. SERDES Power[1]

Symbol	Description	Typ.[2]	Units
$P_{S-1CH-31}$	SERDES power (one channel @ 3.125 Gbps)	90	mW
$P_{S-1CH-25}$	SERDES power (one channel @ 2.5 Gbps)	87	mW
$P_{S-1CH-12}$	SERDES power (one channel @ 1.25 Gbps)	86	mW
$P_{S-1CH-02}$	SERDES power (one channel @ 250 Mbps)	76	mW

1. One quarter of the total quad power (includes contribution from common circuits, all channels in the quad operating, pre-emphasis disabled, equalization enabled).
2. Typical values measured at 25ºC and 1.2V.

BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

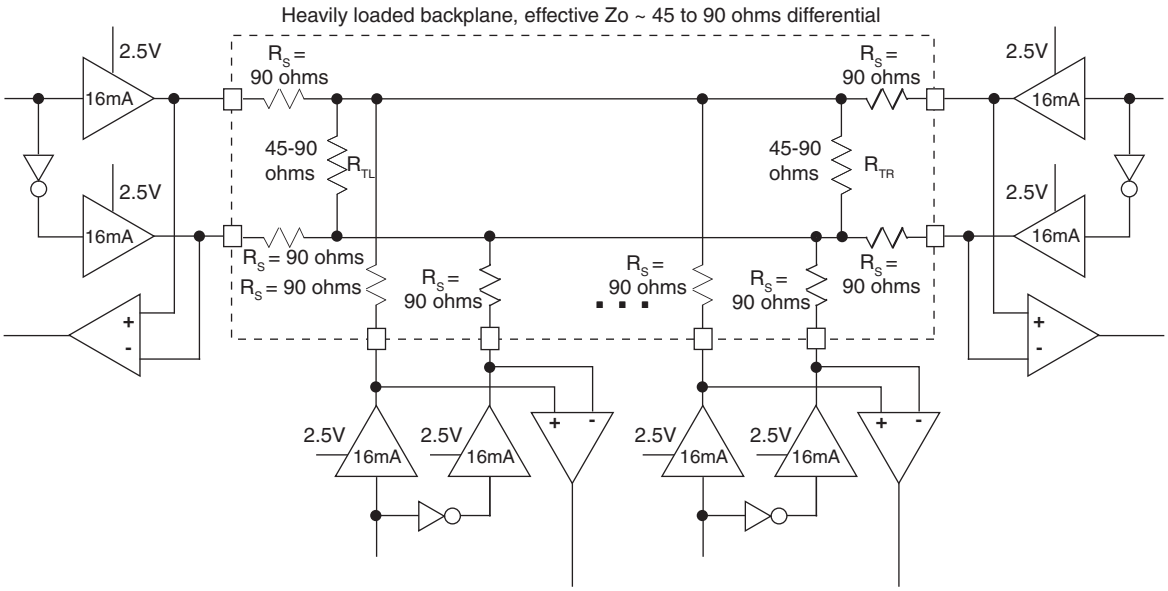


Table 3-3. BLVDS DC Conditions[1]

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45Ω	Zo = 90Ω	
V_{CCIO}	Output Driver Supply (+/- 5%)	2.50	2.50	V
Z_{OUT}	Driver Impedance	10.00	10.00	Ω
R_S	Driver Series Resistor (+/- 1%)	90.00	90.00	Ω
R_{TL}	Driver Parallel Resistor (+/- 1%)	45.00	90.00	Ω
R_{TR}	Receiver Termination (+/- 1%)	45.00	90.00	Ω
V_{OH}	Output High Voltage	1.38	1.48	V
V_{OL}	Output Low Voltage	1.12	1.02	V
V_{OD}	Output Differential Voltage	0.25	0.46	V
V_{CM}	Output Common Mode Voltage	1.25	1.25	V
I_{DC}	DC Output Current	11.24	10.20	mA

1. For input buffer, see LVDS table.

LatticeECP2/M External Switching Characteristics[9] (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
		LFE2M100	1.00	—	1.20	—	1.40	—	ns
t_{SU_DELPLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
		LFE2M100	2.00	—	2.20	—	2.40	—	ns
t_{H_DELPLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns
DDR I/O Pin Parameters[2]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR}	DDR Clock Frequency[6]	ECP2/M	95	200	95	166	95	133	MHz
DDR2 I/O Pin Parameters[3]									
t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

LatticeECP2/M Family Timing Adders[1, 2, 3]

Over Recommended Operating Conditions

Buffer Type	Description	-7	-6	-5	Units
Input Adjusters					
LVDS25	LVDS	-0.04	-0.02	0.00	ns
BLVDS25	BLVDS	-0.04	-0.09	-0.15	ns
MLVDS	LVDS	-0.15	-0.15	-0.15	ns
RSDS	RSDS	-0.15	-0.15	-0.15	ns
LVPECL33	LVPECL	0.16	0.15	0.13	ns
HSTL18_I	HSTL_18 class I	0.01	-0.01	-0.04	ns
HSTL18_II	HSTL_18 class II	0.01	-0.01	-0.04	ns
HSTL18D_I	Differential HSTL 18 class I	0.01	-0.01	-0.04	ns
HSTL18D_II	Differential HSTL 18 class II	0.01	-0.01	-0.04	ns
HSTL15_I	HSTL_15 class I	0.01	-0.01	-0.04	ns
HSTL15D_I	Differential HSTL 15 class I	0.01	-0.01	-0.04	ns
SSTL33_I	SSTL_3 class I	-0.03	-0.07	-0.10	ns
SSTL33_II	SSTL_3 class II	-0.03	-0.07	-0.10	ns
SSTL33D_I	Differential SSTL_3 class I	-0.03	-0.07	-0.10	ns
SSTL33D_II	Differential SSTL_3 class II	-0.03	-0.07	-0.10	ns
SSTL25_I	SSTL_2 class I	-0.04	-0.07	-0.10	ns
SSTL25_II	SSTL_2 class II	-0.04	-0.07	-0.10	ns
SSTL25D_I	Differential SSTL_2 class I	-0.04	-0.07	-0.10	ns
SSTL25D_II	Differential SSTL_2 class II	-0.04	-0.07	-0.10	ns
SSTL18_I	SSTL_18 class I	-0.01	-0.04	-0.07	ns
SSTL18_II	SSTL_18 class II	-0.01	-0.04	-0.07	ns
SSTL18D_I	Differential SSTL_18 class I	-0.01	-0.04	-0.07	ns
SSTL18D_II	Differential SSTL_18 class II	-0.01	-0.04	-0.07	ns
LVTTL33	LVTTL	-0.16	-0.16	-0.16	ns
LVCMOS33	LVCMOS 3.3	-0.08	-0.12	-0.16	ns
LVCMOS25	LVCMOS 2.5	0.00	0.00	0.00	ns
LVCMOS18	LVCMOS 1.8	-0.16	-0.17	-0.17	ns
LVCMOS15	LVCMOS 1.5	-0.14	-0.14	-0.14	ns
LVCMOS12	LVCMOS 1.2	-0.04	-0.01	0.01	ns
PCI33	PCI	-0.08	-0.12	-0.16	ns
Output Adjusters					
LVDS25E	LVDS 2.5 E[4]	0.25	0.19	0.13	ns
LVDS25	LVDS 2.5	0.10	0.13	0.17	ns
BLVDS25	BLVDS 2.5	0.00	-0.01	-0.03	ns
MLVDS	MLVDS 2.5[4]	0.00	-0.01	-0.03	ns
RSDS	RSDS 2.5[4]	0.25	0.19	0.13	ns
LVPECL33	LVPECL 3.3[4]	-0.02	-0.04	-0.06	ns
HSTL18_I	HSTL_18 class I 8mA drive	-0.19	-0.22	-0.25	ns
HSTL18_II	HSTL_18 class II	-0.30	-0.34	-0.37	ns
HSTL18D_I	Differential HSTL 18 class I 8mA drive	-0.19	-0.22	-0.25	ns
HSTL18D_II	Differential HSTL 18 class II	-0.30	-0.34	-0.37	ns

sysCLOCK GPLL Timing

Over Recommended Operating Conditions

Parameter	Description	Conditions	Min.	Typ.	Max.	Units
f_{IN}	Input Clock Frequency (CLKI, CLKFB)	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	420	MHz
f_{OUT}	Output Clock Frequency (CLKOP, CLKOS)	Without external capacitor	20	—	420	MHz
		With external capacitor[5]	5	—	50	MHz
f_{OUT2}	K-Divider Output Frequency (CLKOK)	Without external capacitor	0.156	—	210	MHz
		With external capacitor[5]	0.039	—	25	MHz
f_{VCO}	PLL VCO Frequency		640	—	1280	MHz
f_{PFD}	Phase Detector Input Frequency	Without external capacitor	20	—	420	MHz
		With external capacitor[5, 6]	2	—	50	MHz
AC Characteristics						
t_{DT}	Output Clock Duty Cycle	Default duty cycle selected[3]	45	50	55	%
t_{PH}[4]	Output Phase Accuracy		—	—	±0.05	UI
t_{OPJIT}[1]	Output Clock Period Jitter	$f_{OUT} \geq 100$ MHz	—	—	±125	ps
		$50 \leq f_{OUT} < 100$ MHz	—		0.025	UIPP
		$f_{OUT} < 50$ MHz	—	—	0.04	UIPP
t_{SK}	Input Clock to Output Clock Skew	N/M = integer	—	—	±250	ps
t_W	Output Clock Pulse Width	At 90% or 10%	1	—	—	ns
t_{LOCK}[2]	PLL Lock-in Time	Without external capacitor	—	—	150	µs
		With external capacitor[5]	—	—	500	µs
t_{PA}	Programmable Delay Unit		85	130	360	ps
t_{IPJIT}	Input Clock Period Jitter		—	—	±200	ps
t_{FBKDLY}	External Feedback Delay		—	—	10	ns
t_{HI}	Input Clock High Time	90% to 90%	0.5	—	—	ns
t_{LO}	Input Clock Low Time	10% to 10%	0.5	—	—	ns
t_{RST}	RST Pulse Width (RESETM/RESETK)		15	—	—	ns
	Reset Signal Pulse Width (CNTRST)	Without external capacitor	500	—	—	ns
		With external capacitor[5]	20	—	—	µs

1. Jitter sample is taken over 10,000 samples of the primary PLL output with clean reference clock and no additional I/O pins toggling.
2. Output clock is valid after t_{LOCK} for PLL reset and dynamic delay adjustment.
3. Using LVDS output buffers.
4. Relative to CLKOP.
5. Value of external capacitor: 5.6 nF ±20%, NPO dielectric, ceramic chip capacitor, 1206 or smaller package, connected to PLLCAP pin.
6. f_{OUT} (max) = f_{IN} * 10 for f_{IN} < 5MHz.

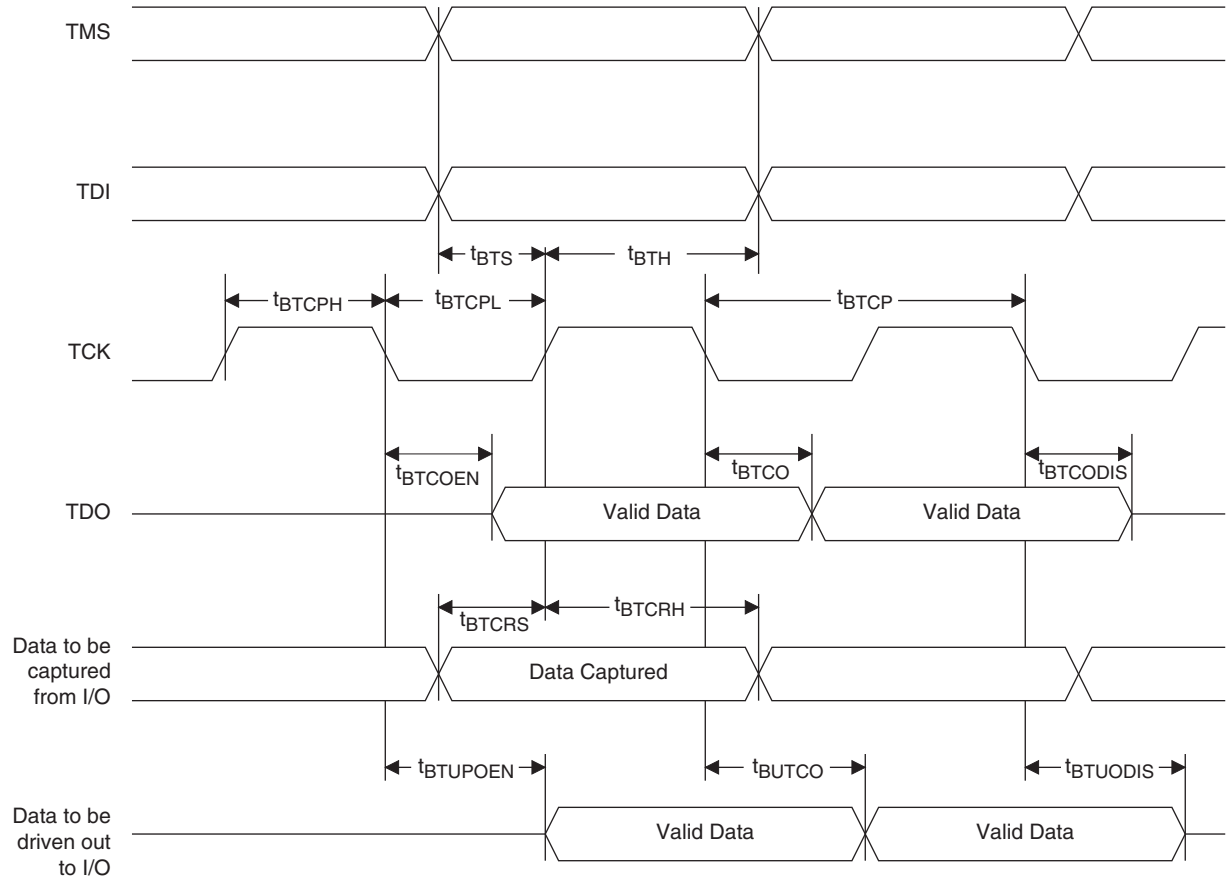
JTAG Port Timing Specifications

Over Recommended Operating Conditions

Symbol	Parameter	Min	Max	Units
f_{MAX}	TCK clock frequency	—	25	MHz
t_{BTCP}	TCK [BSCAN] clock pulse width	40	—	ns
t_{BTCPH}	TCK [BSCAN] clock pulse width high	20	—	ns
t_{BTCPL}	TCK [BSCAN] clock pulse width low	20	—	ns
t_{BTS}	TCK [BSCAN] setup time	8	—	ns
t_{BTH}	TCK [BSCAN] hold time	10	—	ns
t_{BTRF}	TCK [BSCAN] rise/fall time	50	—	mV/ns
t_{BTCO}	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTCODIS}$	TAP controller falling edge of clock to valid disable	—	10	ns
t_{BTCOEN}	TAP controller falling edge of clock to valid enable	—	10	ns
t_{BTCRS}	BSCAN test capture register setup time	8	—	ns
t_{BTCRH}	BSCAN test capture register hold time	25	—	ns
t_{BUTCO}	BSCAN test update register, falling edge of clock to valid output	—	25	ns
$t_{BTUODIS}$	BSCAN test update register, falling edge of clock to valid disable	—	25	ns
$t_{BTUPOEN}$	BSCAN test update register, falling edge of clock to valid enable	—	25	ns

Timing v.A 0.11

Figure 3-21. JTAG Port Timing Waveforms



Signal Descriptions (Cont.)

Signal Name	I/O	Description
[LOC]DQS[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQS, num = ball function number.
[LOC]DQ[num]	I/O	DQ input/output pads: T (top), R (right), B (bottom), L (left), DQ, associated DQS number.
Test and Programming (Dedicated Pins)		
TMS	I	Test Mode Select input, used to control the 1149.1 state machine. Pull-up is enabled during configuration.
TCK	I	Test Clock input pin, used to clock the 1149.1 state machine. No pull-up enabled.
TDI	I	Test Data in pin. Used to load data into device using 1149.1 state machine. After power-up, this TAP port can be activated for configuration by sending appropriate command. (Note: once a configuration port is selected it is locked. Another configuration port cannot be selected until the power-up sequence). Pull-up is enabled during configuration.
TDO	O	Output pin. Test Data Out pin used to shift data out of a device using 1149.1.
VCCJ	—	Power supply pin for JTAG Test Access Port.
Configuration Pads (Used During sysCONFIG)		
CFG[2:0]	I	Mode pins used to specify configuration mode values latched on rising edge of INITN. During configuration, a pull-up is enabled. These are dedicated pins.
INITN	I/O	Open Drain pin. Indicates the FPGA is ready to be configured. During configuration, a pull-up is enabled. It is a dedicated pin.
PROGRAMN	I	Initiates configuration sequence when asserted low. This pin always has an active pull-up. This is a dedicated pin.
DONE	I/O	Open Drain pin. Indicates that the configuration sequence is complete, and the startup sequence is in progress. This is a dedicated pin.
CCLK	I/O	Configuration Clock for configuring an FPGA in sysCONFIG mode.
BUSY/SISPI	I/O	Read control command in SPI or SPIm mode.
CSN	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
CS1N	I	sysCONFIG chip select (active low). During configuration, a pull-up is enabled.
WRITEN	I	Write Data on Parallel port (active low).
D[0]/SPIFASTN	I/O	sysCONFIG Port Data I/O for Parallel mode. sysCONFIG Port Data I/O for SPI or SPIm. When using the SPI or SPIm mode, this pin should either be tied high or low, must not be left floating.
D[1:6]	I/O	sysCONFIG Port Data I/O for Parallel
D[7]/SPID0	I/O	sysCONFIG Port Data I/O for Parallel, SPI, SPIm
DOUT/CSON	O	Output for serial configuration data (rising edge of CCLK) when using sysCONFIG port.
DI/CSSPI0N	I/O	Input for serial configuration data (clocked with CCLK) when using sysCONFIG port. During configuration, a pull-up is enabled. Output when used in SPI/SPIm modes.
Dedicated SERDES Signals[1, 2, 3]		
[LOC]_SQ_VCCAUX33	—	Termination resistor switching power (3.3V). This pin must be tied to 3.3V even if the quad is unused.
[LOC]_SQ_REFCLKN	I	Negative Reference Clock Input
[LOC]_SQ_REFCLKP	I	Positive Reference Clock Input
[LOC]_SQ_VCCP	—	PLL and Reference clock buffer power (1.2V). This pin must be tied to 1.2V even if the quad is unused.

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
N14	CFG1	8			CFG1	8		
N13	PROGRAMN	8			PROGRAMN	8		
N15	CFG0	8			CFG0	8		
P15	PR30B	8	WRITEN	C	PR30B	8	WRITEN	C
L12	INITN	8			INITN	8		
N16	PR29B	8	CSN	C	PR29B	8	CSN	C
GND	GNDIO8	-			GNDIO8	-		
R14	CCLK	8			CCLK	8		
P14	PR30A	8	CS1N	T	PR30A	8	CS1N	T
M13	DONE	8			DONE	8		
R16	PR28B	8	D1	C	PR28B	8	D1	C
VCCIO	VCCIO8	8			VCCIO8	8		
M16	PR29A	8	D0/SPIFASTN	T	PR29A	8	D0/SPIFASTN	T
P16	PR28A	8	D2	T	PR28A	8	D2	T
L15	PR27B	8	D3	C	PR27B	8	D3	C
GND	GNDIO8	-			GNDIO8	-		
L14	PR26A	8	D6	T	PR26A	8	D6	T
L16	PR27A	8	D4	T	PR27A	8	D4	T
L10	PR25B	8	D7/SPID0	C	PR25B	8	D7/SPID0	C
L13	PR26B	8	D5	C	PR26B	8	D5	C
VCCIO	VCCIO8	8			VCCIO8	8		
K11	PR25A	8	DI/CSSPI0N	T	PR25A	8	DI/CSSPI0N	T
K14	PR24B	8	DOUT/CSON	C	PR24B	8	DOUT/CSON	C
K13	PR24A	8	BUSY/SISPI	T	PR24A	8	BUSY/SISPI	T
GND	GNDIO8	-			GNDIO8	-		
K15	PR21B	3	RLM0_GPLLC_FB_A	C	PR21B	3	RLM0_GPLLC_FB_A	C
VCCIO	VCCIO3	3			VCCIO3	3		
K16	PR21A	3	RLM0_GPLLT_FB_A	T	PR21A	3	RLM0_GPLLT_FB_A	T
GND	GNDIO3	-			GNDIO3	-		
J16	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*	PR20B	3	RLM0_GPLLC_IN_A**	C (LVDS)*
J15	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*	PR20A	3	RLM0_GPLLT_IN_A**	T (LVDS)*
J14	RLM0_PLLCAP	3			RLM0_PLLCAP	3		
J13	PR18B	3	RLM0_GDLLC_FB_A	C	PR18B	3	RLM0_GDLLC_FB_A	C
J12	PR18A	3	RLM0_GDLLT_FB_A	T	PR18A	3	RLM0_GDLLT_FB_A	T
H12	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*	PR17B	3	RLM0_GDLLC_IN_A**	C (LVDS)*
GND	GNDIO3	-			GNDIO3	-		
H13	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*	PR17A	3	RLM0_GDLLT_IN_A**	T (LVDS)*
H15	PR16B	3	VREF2_3	C	PR16B	3	VREF2_3	C
VCCIO	VCCIO3	3			VCCIO3	3		
H16	PR16A	3	VREF1_3	T	PR16A	3	VREF1_3	T
H11	PR15B	3	PCLKC3_0	C (LVDS)*	PR15B	3	PCLKC3_0	C (LVDS)*
J11	PR15A	3	PCLKT3_0	T (LVDS)*	PR15A	3	PCLKT3_0	T (LVDS)*
G16	PR13B	2	PCLKC2_0/RDQ10	C	PR13B	2	PCLKC2_0/RDQ10	C
GND	GNDIO2	-			GNDIO2	-		
G15	PR13A	2	PCLKT2_0/RDQ10	T	PR13A	2	PCLKT2_0/RDQ10	T

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F19	PR5A	2		T	PR7A	2	RDQ8	T
D20	PR4A	2		T (LVDS)*	PR6A	2	RDQ8	T (LVDS)*
F18	PR3B	2		C	PR5B	2	RDQ8	C
VCCIO	VCCIO2	2			VCCIO2	2		
C21	NC	-			PR4B	2	RDQ8	C (LVDS)*
F16	PR3A	2		T	PR5A	2	RDQ8	T
C22	NC	-			PR4A	2	RDQ8	T (LVDS)*
-	-	-			GNDIO	-		
D19	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
E19	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
B21	PT55B	1	VREF2_1	C	PT64B	1	VREF2_1	C
B22	PT55A	1	VREF1_1	T	PT64A	1	VREF1_1	T
GNDIO	GNDIO1	-			GNDIO1	-		
D18	PT53B	1		C	PT62B	1		C
C20	PT54B	1		C	PT63B	1		C
E18	PT53A	1		T	PT62A	1		T
C19	PT54A	1		T	PT63A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D17	PT51B	1		C	PT60B	1		C
B20	PT52B	1		C	PT61B	1		C
C18	PT51A	1		T	PT60A	1		T
A19	PT52A	1		T	PT61A	1		T
GNDIO	GNDIO1	-			GNDIO1	-		
A18	PT49B	1		C	PT58B	1		C
A21	PT50B	1		C	PT59B	1		C
B18	PT49A	1		T	PT58A	1		T
A20	PT50A	1		T	PT59A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D16	PT47B	1		C	PT56B	1		C
G16	PT48B	1		C	PT57B	1		C
E16	PT47A	1		T	PT56A	1		T
G15	PT48A	1		T	PT57A	1		T
C17	PT46B	1		C	PT55B	1		C
GNDIO	GNDIO1	-			GNDIO1	-		
C16	PT46A	1		T	PT55A	1		T
A17	PT44B	1		C	PT53B	1		C
B17	PT45B	1		C	PT54B	1		C
A16	PT44A	1		T	PT53A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
B16	PT45A	1		T	PT54A	1		T
E15	PT42B	1		C	PT51B	1		C
C15	PT43B	1		C	PT52B	1		C
F15	PT42A	1		T	PT51A	1		T
D15	PT43A	1		T	PT52A	1		T

LFE2-12E/SE and LFE2-20E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2-12E/12SE					LFE2-20E/20SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
C2	PT3A	0		T	PT3A	0		T
J10	VCC	-			VCC	-		
J11	VCC	-			VCC	-		
J12	VCC	-			VCC	-		
J13	VCC	-			VCC	-		
K14	VCC	-			VCC	-		
K9	VCC	-			VCC	-		
L14	VCC	-			VCC	-		
L9	VCC	-			VCC	-		
M14	VCC	-			VCC	-		
M9	VCC	-			VCC	-		
N14	VCC	-			VCC	-		
N9	VCC	-			VCC	-		
P10	VCC	-			VCC	-		
P11	VCC	-			VCC	-		
P12	VCC	-			VCC	-		
P13	VCC	-			VCC	-		
G10	VCCIO0	0			VCCIO0	0		
G9	VCCIO0	0			VCCIO0	0		
H9	VCCIO0	0			VCCIO0	0		
H8	VCCIO0	0			VCCIO0	0		
G11	VCCIO1	1			VCCIO1	1		
G12	VCCIO1	1			VCCIO1	1		
G13	VCCIO1	1			VCCIO1	1		
G14	VCCIO1	1			VCCIO1	1		
H14	VCCIO2	2			VCCIO2	2		
H15	VCCIO2	2			VCCIO2	2		
J15	VCCIO2	2			VCCIO2	2		
K16	VCCIO2	2			VCCIO2	2		
L16	VCCIO3	3			VCCIO3	3		
M16	VCCIO3	3			VCCIO3	3		
N16	VCCIO3	3			VCCIO3	3		
P16	VCCIO3	3			VCCIO3	3		
R14	VCCIO4	4			VCCIO4	4		
T12	VCCIO4	4			VCCIO4	4		
T13	VCCIO4	4			VCCIO4	4		
T14	VCCIO4	4			VCCIO4	4		
R9	VCCIO5	5			VCCIO5	5		
T10	VCCIO5	5			VCCIO5	5		
T11	VCCIO5	5			VCCIO5	5		
T9	VCCIO5	5			VCCIO5	5		
N7	VCCIO6	6			VCCIO6	6		
P7	VCCIO6	6			VCCIO6	6		
P8	VCCIO6	6			VCCIO6	6		

LFE2-70E/SE Logic Signal Connections: 900 fpBGA

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
VCCIO	VCCIO7	7		
F4	PL2A	7	VREF2_7	T (LVDS)*
F3	PL2B	7	VREF1_7	C (LVDS)*
H4	PL3A	7		T
G5	PL3B	7		C
GND	GNDIO7	-		
D2	PL4A	7		T (LVDS)*
D1	PL4B	7		C (LVDS)*
E2	PL5A	7		T
VCCIO	VCCIO7	7		
E1	PL5B	7		C
GND	GNDIO7	-		
VCCIO	VCCIO7	7		
F1	PL14A	7	LUM1_SPLLT_IN_A/LDQ12	T (LVDS)*
F2	PL14B	7	LUM1_SPLLC_IN_A/LDQ12	C (LVDS)*
G1	PL15A	7	LUM1_SPLLT_FB_A/LDQ12	T
G2	PL15B	7	LUM1_SPLLC_FB_A/LDQ12	C
GND	GNDIO7	-		
H8	PL18A	7	LDQ21	T
H6	PL18B	7	LDQ21	C
VCCIO	VCCIO7	7		
G4	PL19A	7	LDQ21	T (LVDS)*
G3	PL19B	7	LDQ21	C (LVDS)*
H7	PL20A	7	LDQ21	T
H5	PL20B	7	LDQ21	C
GND	GNDIO7	-		
H2	PL21A	7	LDQS21	T (LVDS)*
H1	PL21B	7	LDQ21	C (LVDS)*
J6	PL22A	7	LDQ21	T
VCCIO	VCCIO7	7		
J8	PL22B	7	LDQ21	C
J2	PL23A	7	LDQ21	T (LVDS)*
J1	PL23B	7	LDQ21	C (LVDS)*
J5	PL24A	7	LDQ21	T
GND	GNDIO7	-		
J7	PL24B	7	LDQ21	C
J4	PL25A	7	LDQ29	T (LVDS)*
J3	PL25B	7	LDQ29	C (LVDS)*
K6	PL26A	7	LDQ29	T
K8	PL26B	7	LDQ29	C
VCCIO	VCCIO7	7		
K2	PL27A	7	LDQ29	T (LVDS)*

LFE2-70E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2-70E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
P25	PR51B	2	RDQ54	C
VCCIO	VCCIO2	2		
P23	PR51A	2	RDQ54	T
P27	PR50B	2	RDQ54	C (LVDS)*
P28	PR50A	2	RDQ54	T (LVDS)*
GND	GNDIO2	-		
VCCIO	VCCIO2	2		
N24	PR39B	2	RUM0_SPLLC_FB_A/RDQ37	C
N26	PR39A	2	RUM0_SPLLT_FB_A/RDQ37	T
N23	PR38B	2	RUM0_SPLLC_IN_A/RDQ37	C
N25	PR38A	2	RUM0_SPLLT_IN_A/RDQ37	T
VCCIO	VCCIO2	2		
P29	PR37B	2	RDQ37	C (LVDS)*
P30	PR37A	2	RDQS37	T (LVDS)*
M26	PR36B	2	RDQ37	C
GND	GNDIO2	-		
M24	PR36A	2	RDQ37	T
N29	PR35B	2	RDQ37	C (LVDS)*
N30	PR35A	2	RDQ37	T (LVDS)*
M25	PR34B	2	RDQ37	C
VCCIO	VCCIO2	2		
M23	PR34A	2	RDQ37	T
M27	PR33B	2	RDQ37	C (LVDS)*
M28	PR33A	2	RDQ37	T (LVDS)*
L26	PR32B	2	RDQ29	C
GND	GNDIO2	-		
L24	PR32A	2	RDQ29	T
M29	PR31B	2	RDQ29	C (LVDS)*
M30	PR31A	2	RDQ29	T (LVDS)*
L25	PR30B	2	RDQ29	C
VCCIO	VCCIO2	2		
L23	PR30A	2	RDQ29	T
L27	PR29B	2	RDQ29	C (LVDS)*
L28	PR29A	2	RDQS29	T (LVDS)*
GND	GNDIO2	-		
K24	PR28B	2	RDQ29	C
K26	PR28A	2	RDQ29	T
L29	PR27B	2	RDQ29	C (LVDS)*
L30	PR27A	2	RDQ29	T (LVDS)*
VCCIO	VCCIO2	2		
K23	PR26B	2	RDQ29	C
K25	PR26A	2	RDQ29	T
K27	PR25B	2	RDQ29	C (LVDS)*

LFE2M50E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M50E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
GNDIO	GNDIO7	-		
L1	PL36A	7	LDQS36	T (LVDS)*
L2	PL36B	7	LDQ36	C (LVDS)*
M7	PL37A	7	LDQ36	T
VCCIO	VCCIO7	7		
L5	PL37B	7	LDQ36	C
L3	PL38A	7	LDQ36	T (LVDS)*
L4	PL38B	7	LDQ36	C (LVDS)*
M1	PL39A	7	PCLKT7_0/LDQ36	T
GNDIO	GNDIO7	-		
M2	PL39B	7	PCLKC7_0/LDQ36	C
M6	PL41A	6	PCLKT6_0	T (LVDS)*
M5	PL41B	6	PCLKC6_0	C (LVDS)*
M3	PL42A	6	VREF2_6	T
M4	PL42B	6	VREF1_6	C
VCCIO	VCCIO6	6		
N7	PL45A	6	LLM3_SPLLT_IN_A	T (LVDS)*
GNDIO	GNDIO6	-		
N6	PL45B	6	LLM3_SPLLC_IN_A	C (LVDS)*
N1	PL46A	6	LLM3_SPLLT_FB_A	T
N2	PL46B	6	LLM3_SPLLC_FB_A	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
P6	PL52A	6	LDQS52****	T (LVDS)*
N5	PL52B	6	LDQ52	C (LVDS)*
P1	PL53A	6	LDQ52	T
VCCIO	VCCIO6	6		
P2	PL53B	6	LDQ52	C
P3	PL54A	6	LDQ52	T (LVDS)*
P4	PL54B	6	LDQ52	C (LVDS)*
P5	PL55A	6	LDQ52	T
GNDIO	GNDIO6	-		
P7	PL55B	6	LDQ52	C
VCCIO	VCCIO6	6		
GNDIO	GNDIO6	-		
R1	PL62A	6	LLM0_GPLLT_IN_A**	T (LVDS)*
GNDIO	GNDIO6	-		
R2	PL62B	6	LLM0_GPLLC_IN_A**	C (LVDS)*
R3	PL63A	6	LLM0_GPLLT_FB_A	T
R4	PL63B	6	LLM0_GPLLC_FB_A	C
VCCIO	VCCIO6	6		
R6	PL64A	6	LLM0_GDLLT_IN_A**	T (LVDS)*
R5	PL64B	6	LLM0_GDLLC_IN_A**	C (LVDS)*

LFE2M35E/SE and LFE2M50E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2M35E/SE					LFE2M50E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
D23	NC	-			NC	-		
D24	NC	-			NC	-		
D25	NC	-			NC	-		
D26	NC	-			NC	-		
E20	NC	-			NC	-		
E21	NC	-			NC	-		
E25	NC	-			NC	-		
E26	NC	-			NC	-		
F20	NC	-			NC	-		
G20	NC	-			NC	-		
K10	NC	-			NC	-		
K17	NC	-			NC	-		
R4	NC	-			NC	-		
U10	NC	-			NC	-		
U23	NC	-			NC	-		
V10	NC	-			NC	-		
W7	NC	-			NC	-		
AB21	PB69B	4	BDQ69	C	NC	-		
AC20	PB58A	4	BDQ60	T	NC	-		
AC21	PB63A	4	BDQ60	T	NC	-		
AC22	PB69A	4	BDQS69****	T	NC	-		
AC23	PB71A	4	BDQ69	T	NC	-		
AC25	PB71B	4	BDQ69	C	NC	-		
AD26	PB70B	4	BDQ69	C	NC	-		
W20	PB72B	4	BDQ69	C	NC	-		
H7	L_VCCPLL	-			L_VCCPLL	-		
K6	L_VCCPLL	-			L_VCCPLL	-		
P7	L_VCCPLL	-			L_VCCPLL	-		
R8	L_VCCPLL	-			L_VCCPLL	-		
V18	R_VCCPLL	-			R_VCCPLL	-		
P20	R_VCCPLL	-			R_VCCPLL	-		
J17	R_VCCPLL	-			R_VCCPLL	-		
G19	R_VCCPLL	-			R_VCCPLL	-		

* Supports true LVDS. Other differential signals must be emulated with external resistors.
** These dedicated input pins can be used for GPLLs or GDLLs within the respective quadrant.
*** For density migration, board design must take into account that these sysCONFIG pins are dual function for the lower density devices (ECP2M20 and ECP2M35). They can be either sysCONFIG pins or general purpose I/Os. These pins are dedicated pins for the higher density devices (ECP2M50, ECP2M70 and ECP2M100).
****Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
H14	PT61A	0		T
A14	PT60B	0		C
B14	PT60A	0		T
D13	PT59B	0		C
GNDIO	GNDIO0	-		
F13	PT59A	0		T
G13	PT58B	0		C
VCCIO	VCCIO0	0		
J11	PT58A	0		T
D4	PT57B	0		
D5	PT56A	0		
E5	PT55B	0		C
F6	PT55A	0		T
GNDIO	GNDIO0	-		
VCCIO	VCCIO0	0		
F7	PT52B	0		C
D8	PT52A	0		T
GNDIO	GNDIO0	-		
J13	PT50B	0		C
G11	PT50A	0		T
H13	PT49B	0		C
H12	PT49A	0		T
VCCIO	VCCIO0	0		
E8	PT48B	0		C
D9	PT48A	0		T
D12	PT46B	0		C
GNDIO	GNDIO0	-		
E13	PT46A	0		T
VCCIO	VCCIO0	0		
GNDIO	GNDIO0	-		
J12	PT31B	0		C
-	-	-		
VCCIO	VCCIO0	0		
H10	PT31A	0		T
E12	PT30B	0		C
D11	PT30A	0		T
H11	PT29B	0		C
F11	PT29A	0		T
C13	ULC_SQ_VCCRX0	11		
A12	ULC_SQ_HDINP0	11		T
B13	ULC_SQ_VCCIB0	11		
B12	ULC_SQ_HDINN0	11		C
C10	ULC_SQ_VCCTX0	11		

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	**Ball/Pad Function**	**Bank**	**Dual Function**	**Differential**
AE23	NC	-		
AE5	NC	-		
AE6	NC	-		
AE7	NC	-		
AF20	NC	-		
AF23	NC	-		
AF5	NC	-		
AG23	NC	-		
AG26	NC	-		
D10	NC	-		
E10	NC	-		
E11	NC	-		
F10	NC	-		
F20	NC	-		
F23	NC	-		
F8	NC	-		
G10	NC	-		
G20	NC	-		
G21	NC	-		
G7	NC	-		
G8	NC	-		
G9	NC	-		
H19	NC	-		
H20	NC	-		
H21	NC	-		
H22	NC	-		
H6	NC	-		
H8	NC	-		
H9	NC	-		
J10	NC	-		
J20	NC	-		
J21	NC	-		
J9	NC	-		
K9	NC	-		
R9	NC	-		
U22	NC	-		
W9	NC	-		
N13	VCCPLL	-		
N18	VCCPLL	-		
V13	VCCPLL	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AE12	NC	-			NC	-		
AE13	NC	-			NC	-		
AE19	NC	-			NC	-		
AE21	NC	-			NC	-		
AE22	NC	-			NC	-		
AE23	NC	-			NC	-		
AF11	NC	-			NC	-		
AF21	NC	-			NC	-		
AF22	NC	-			NC	-		
AF24	NC	-			NC	-		
AF8	NC	-			NC	-		
AF9	NC	-			NC	-		
AG10	NC	-			NC	-		
AG11	NC	-			NC	-		
AG24	NC	-			NC	-		
AG25	NC	-			NC	-		
AG26	NC	-			NC	-		
AG3	NC	-			NC	-		
AG7	NC	-			NC	-		
AG8	NC	-			NC	-		
AG9	NC	-			NC	-		
AH10	NC	-			NC	-		
AH11	NC	-			NC	-		
AH13	NC	-			NC	-		
AH24	NC	-			NC	-		
AH25	NC	-			NC	-		
AH26	NC	-			NC	-		
AH27	NC	-			NC	-		
AH5	NC	-			NC	-		
AH6	NC	-			NC	-		
AH7	NC	-			NC	-		
AH8	NC	-			NC	-		
AH9	NC	-			NC	-		
AJ10	NC	-			NC	-		
AJ11	NC	-			NC	-		
AJ13	NC	-			NC	-		
AJ24	NC	-			NC	-		
AJ25	NC	-			NC	-		
AJ26	NC	-			NC	-		
AJ27	NC	-			NC	-		
AJ3	NC	-			NC	-		
AJ4	NC	-			NC	-		
AJ5	NC	-			NC	-		
AJ6	NC	-			NC	-		
AJ7	NC	-			NC	-		
AJ8	NC	-			NC	-		
AJ9	NC	-			NC	-		
AK10	NC	-			NC	-		
AK11	NC	-			NC	-		

LatticeECP2 Standard Series Devices, Conventional Packaging

Commercial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144C	90	1.2V	-5	TQFP	144	COM	6
LFE2-6E-6T144C	90	1.2V	-6	TQFP	144	COM	6
LFE2-6E-7T144C	90	1.2V	-7	TQFP	144	COM	6
LFE2-6E-5F256C	190	1.2V	-5	fpBGA	256	COM	6
LFE2-6E-6F256C	190	1.2V	-6	fpBGA	256	COM	6
LFE2-6E-7F256C	190	1.2V	-7	fpBGA	256	COM	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144C	93	1.2V	-5	TQFP	144	COM	12
LFE2-12E-6T144C	93	1.2V	-6	TQFP	144	COM	12
LFE2-12E-7T144C	93	1.2V	-7	TQFP	144	COM	12
LFE2-12E-5Q208C	131	1.2V	-5	PQFP	208	COM	12
LFE2-12E-6Q208C	131	1.2V	-6	PQFP	208	COM	12
LFE2-12E-7Q208C	131	1.2V	-7	PQFP	208	COM	12
LFE2-12E-5F256C	193	1.2V	-5	fpBGA	256	COM	12
LFE2-12E-6F256C	193	1.2V	-6	fpBGA	256	COM	12
LFE2-12E-7F256C	193	1.2V	-7	fpBGA	256	COM	12
LFE2-12E-5F484C	297	1.2V	-5	fpBGA	484	COM	12
LFE2-12E-6F484C	297	1.2V	-6	fpBGA	484	COM	12
LFE2-12E-7F484C	297	1.2V	-7	fpBGA	484	COM	12

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-20E-5Q208C	131	1.2V	-5	PQFP	208	COM	20
LFE2-20E-6Q208C	131	1.2V	-6	PQFP	208	COM	20
LFE2-20E-7Q208C	131	1.2V	-7	PQFP	208	COM	20
LFE2-20E-5F256C	193	1.2V	-5	fpBGA	256	COM	20
LFE2-20E-6F256C	193	1.2V	-6	fpBGA	256	COM	20
LFE2-20E-7F256C	193	1.2V	-7	fpBGA	256	COM	20
LFE2-20E-5F484C	331	1.2V	-5	fpBGA	484	COM	20
LFE2-20E-6F484C	331	1.2V	-6	fpBGA	484	COM	20
LFE2-20E-7F484C	331	1.2V	-7	fpBGA	484	COM	20
LFE2-20E-5F672C	402	1.2V	-5	fpBGA	672	COM	20
LFE2-20E-6F672C	402	1.2V	-6	fpBGA	672	COM	20
LFE2-20E-7F672C	402	1.2V	-7	fpBGA	672	COM	20

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-35E-5F484C	331	1.2V	-5	fpBGA	484	COM	35
LFE2-35E-6F484C	331	1.2V	-6	fpBGA	484	COM	35
LFE2-35E-7F484C	331	1.2V	-7	fpBGA	484	COM	35
LFE2-35E-5F672C	450	1.2V	-5	fpBGA	672	COM	35
LFE2-35E-6F672C	450	1.2V	-6	fpBGA	672	COM	35
LFE2-35E-7F672C	450	1.2V	-7	fpBGA	672	COM	35

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-50E-5F484C	339	1.2V	-5	fpBGA	484	COM	50
LFE2-50E-6F484C	339	1.2V	-6	fpBGA	484	COM	50
LFE2-50E-7F484C	339	1.2V	-7	fpBGA	484	COM	50
LFE2-50E-5F672C	500	1.2V	-5	fpBGA	672	COM	50
LFE2-50E-6F672C	500	1.2V	-6	fpBGA	672	COM	50
LFE2-50E-7F672C	500	1.2V	-7	fpBGA	672	COM	50

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-70E-5F672C	500	1.2V	-5	fpBGA	672	COM	70
LFE2-70E-6F672C	500	1.2V	-6	fpBGA	672	COM	70
LFE2-70E-7F672C	500	1.2V	-7	fpBGA	672	COM	70
LFE2-70E-5F900C	583	1.2V	-5	fpBGA	900	COM	70
LFE2-70E-6F900C	583	1.2V	-6	fpBGA	900	COM	70
LFE2-70E-7F900C	583	1.2V	-7	fpBGA	900	COM	70

Industrial

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-6E-5T144I	90	1.2V	-5	TQFP	144	IND	6
LFE2-6E-6T144I	90	1.2V	-6	TQFP	144	IND	6
LFE2-6E-5F256I	190	1.2V	-5	fpBGA	256	IND	6
LFE2-6E-6F256I	190	1.2V	-6	fpBGA	256	IND	6

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs (K)
LFE2-12E-5T144I	93	1.2V	-5	TQFP	144	IND	12
LFE2-12E-6T144I	93	1.2V	-6	TQFP	144	IND	12
LFE2-12E-5Q208I	131	1.2V	-5	PQFP	208	IND	12
LFE2-12E-6Q208I	131	1.2V	-6	PQFP	208	IND	12
LFE2-12E-5F256I	193	1.2V	-5	fpBGA	256	IND	12
LFE2-12E-6F256I	193	1.2V	-6	fpBGA	256	IND	12
LFE2-12E-5F484I	297	1.2V	-5	fpBGA	484	IND	12
LFE2-12E-6F484I	297	1.2V	-6	fpBGA	484	IND	12

Date	Version	Section	Change Summary
August 2007 (cont.)	02.8 (cont.)	DC and Switching (cont.)	sysCLOCK GPLL timing has been updated.
		Pinout Information	Added ECP2M50 (484/672/900-fpBGA), ECP2M70 (900-fpBGA) and ECP2M100 (900-fpBGA) pinout information.
		Ordering Information	1156-fpBGA package option has been removed from the LatticeECP2M family.
September 2007	02.9	Pinout Information	Added Thermal Management text section.
February 2008	03.0	Architecture	Added LVCMOS33D description.
		DC and Switching	LatticeECP2M Supply Current has been updated.
			Typical Building Block Function Performance, External Switching Characteristics, Internal Switching Characteristics, Family Timing Adders, sysCLOCK GPLL Timing, sysCLOCK SPLL Timing, DLL Timing and sysCONFIG Port Timing Specifications have been updated (timing rev. A 0.11).
			Figure 3-9. Read/Write Mode (Normal) and Figure 3-10. Read/Write Mode with Input and Output Registers have been updated.
			Table 3-8. Channel output Jitter (Max) has been updated.
		Pinout Information	Signal description has been updated.
			Added 1152-fpBGA pinouts for the ECP2M70 and ECP2M100.
April 2008	03.1	Pinout Information	Available DDR Interfaces per I/O Bank for the LFE2M35 (484/672-fpBGA) have been updated.
June 2008	03.2	Introduction	Family Selection Guide table - Updated number of EBR SRAM Blocks for the ECP2-70 device.
		Architecture	Removed Read-Before-Write sysMEM EBR mode.
			Clarification of the operation of the secondary clock regions.
		DC and Switching Characteristics	Removed Read-Before-Write sysMEM EBR mode.
August 2008	03.3	Architecture	Clarification of the operation of the secondary clock regions.
		Pinout Information	Added information for [LOC]DQ[num] to Signal Descriptions table.
January 2009	03.4	DC and Switching Characteristics	Updated typical and max. jitter numbers in Channel Output Jitter table for x10 mode.
			Added Channel Output Jitter table for x20 mode.
November 2009	03.5	DC and Switching Characteristics	Updated SPI/SPIm Configuration Waveforms diagram.
			Updated footnotes in LatticeECP2 Initialization Supply Current table.
			Updated footnotes in LatticeECP2M Initialization Supply Current table.
			Updated footnotes in SERDES High Speed Data Receiver (LatticeECP2M Family Only) table.
			Updated max. value for t_{DINIT} parameter in LatticeECP2/M sysCONFIG Port Timing Specifications table.
			Updated Serial Output Timing and Levels table.
			Updated Figure 3-5 MLVDS
			Updated Table 3-7 Serial Output Timing and Levels
			Updated Table 3-15 Power Down/Power Up Specification
		Pinout Information	Signal Descriptions table - corrected references to ULM, URM, LRM (changed to LUM, RUM and RLM), added footnote 5.